# onsemi

# <u>MOSFET</u> – Power, Single, N-Channel, DFN5/DFNW5

**40 V, 1.3 m**Ω**, 235 A** 

# NVMFS5C426N

## Features

- Small Footprint (5x6 mm) for Compact Design
- Low R<sub>DS(on)</sub> to Minimize Conduction Losses
- Low Q<sub>G</sub> and Capacitance to Minimize Driver Losses
- NVMFS5C426NWF Wettable Flank Option for Enhanced Optical Inspection
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

#### MAXIMUM RATINGS (T<sub>J</sub> = 25°C unless otherwise noted)

Symbol	Parar	neter		Value	Unit
V <sub>DSS</sub>	Drain-to-Source Voltag		40	V	
V <sub>GS</sub>	Gate-to-Source Voltage	Э		±20	V
۱ <sub>D</sub>	Continuous Drain		$T_{C} = 25^{\circ}C$	235	А
	Current R <sub>θJC</sub> (Notes 1, 3)	Steady	$T_{\rm C} = 100^{\circ}{\rm C}$	166	
PD	Power Dissipation	State	T <sub>C</sub> = 25°C	128	W
	R <sub>θJC</sub> (Note 1)		$T_{\rm C} = 100^{\circ}{\rm C}$	64	
Ι <sub>D</sub>	Continuous Drain		T <sub>A</sub> = 25°C	41	А
	Current R <sub>θJA</sub> (Notes 1, 2, 3)	Steady	$T_A = 100^{\circ}C$	29	
PD	Power Dissipation	State	T <sub>A</sub> = 25°C	3.8	W
	R <sub>θJA</sub> (Notes 1 & 2)		$T_A = 100^{\circ}C$	1.9	
I <sub>DM</sub>	Pulsed Drain Current	T <sub>A</sub> = 25	°C, t <sub>p</sub> = 10 μs	900	А
T <sub>J</sub> , T <sub>stg</sub>	Operating Junction and	–55 to + 175	°C		
۱ <sub>S</sub>	Source Current (Body D	122	А		
E <sub>AS</sub>	Single Pulse Drain-to-S Energy (I <sub>L(pk)</sub> = 19 A)	739	mJ		
ΤL	Lead Temperature for S (1/8" from case for 10 s		urposes	260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

#### THERMAL RESISTANCE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
$R_{\theta JC}$	Junction-to-Case - Steady State		°C/W
$R_{\theta JA}$	Junction-to-Ambient - Steady State (Note 2)	39	

1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

2. Surface-mounted on FR4 board using a 650 mm<sup>2</sup>, 2 oz. Cu pad.

3. Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.

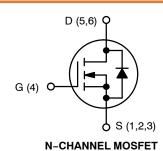
V <sub>(BR)DSS</sub>	R <sub>DS(ON)</sub> MAX	I <sub>D</sub> MAX
40 V	1.3 m $\Omega$ @ 10 V	235 A



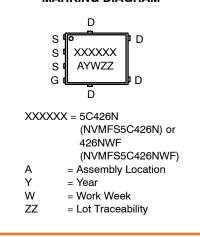
DFN5 (SO-8FL) CASE 488AA



DFNW5 (FULL-CUT SO8FL WF) CASE 507BA



# MARKING DIAGRAM



# **ORDERING INFORMATION**

See detailed ordering, marking and shipping information in the package dimensions section on page 5 of this data sheet.

NOTE: Some of the devices on this data sheet have been **DISCONTINUED**. Please refer to the table on page 5.

#### ELECTRICAL CHARACTERISTICS (T<sub>J</sub> = 25°C unless otherwise specified)

Symbol	Parameter	Test Condition		Min	Тур	Max	Unit	
OFF CHAR	OFF CHARACTERISTICS							
V <sub>(BR)DSS</sub>	Drain-to-Source Breakdown Voltage	$V_{GS}$ = 0 V, $I_D$ = 250 $\mu$ A		40			V	
V <sub>(BR)DSS</sub> / T <sub>J</sub>	Drain-to-Source Breakdown Voltage Temperature Coefficient				9.6		mV/°C	
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 40 V	$V_{GS} = 0 V,$ $T_J = 25^{\circ}C$			10		
		v <sub>DS</sub> = 40 v	T <sub>J</sub> = 125°C			100	μΑ	
I <sub>GSS</sub>	Gate-to-Source Leakage Current	V <sub>DS</sub> = 0 V, V <sub>GS</sub> = 20 V				100	nA	

#### **ON CHARACTERISTICS** (Note 4)

V <sub>GS(TH)</sub>	Gate Threshold Voltage	$V_{GS} = V_{DS}, I_D = 170 \ \mu A$		2.5		3.5	V
$V_{GS(TH)}/T_J$	Threshold Temperature Coefficient				-8.6		mV/°C
R <sub>DS(on)</sub>	Drain-to-Source On Resistance	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 50 A		1.1	1.3	mΩ
<b>9</b> FS	Forward Transconductance	V <sub>DS</sub> =15 V, I <sub>D</sub> = 50 A			145		S

## **CHARGES, CAPACITANCES & GATE RESISTANCE**

C <sub>ISS</sub>	Input Capacitance		4300	
C <sub>OSS</sub>	Output Capacitance	$V_{GS}$ = 0 V, f = 1 MHz, $V_{DS}$ = 25 V	2100	pF
C <sub>RSS</sub>	Reverse Transfer Capacitance		59	
Q <sub>G(TOT)</sub>	Total Gate Charge	$V_{GS}$ = 10 V, $V_{DS}$ = 20 V; $I_{D}$ = 50 A	65	
Q <sub>G(TH)</sub>	Threshold Gate Charge		13	nC
Q <sub>GS</sub>	Gate-to-Source Charge		20	nc
Q <sub>GD</sub>	Gate-to-Drain Charge	V <sub>GS</sub> = 10 V, V <sub>DS</sub> = 20 V; I <sub>D</sub> = 50 A	12	
V <sub>GP</sub>	Plateau Voltage		4.7	V

#### SWITCHING CHARACTERISTICS (Note 5)

t <sub>d(ON)</sub>	Turn-On Delay Time		15	
t <sub>r</sub>	Rise Time	V <sub>GS</sub> = 10 V, V <sub>DS</sub> = 20 V,	47	20
t <sub>d(OFF)</sub>	Turn-Off Delay Time	$I_{\rm D} = 50 \text{ A}, \text{ R}_{\rm G} = 2.5 \Omega$	36	ns
t <sub>f</sub>	Fall Time		9.0	

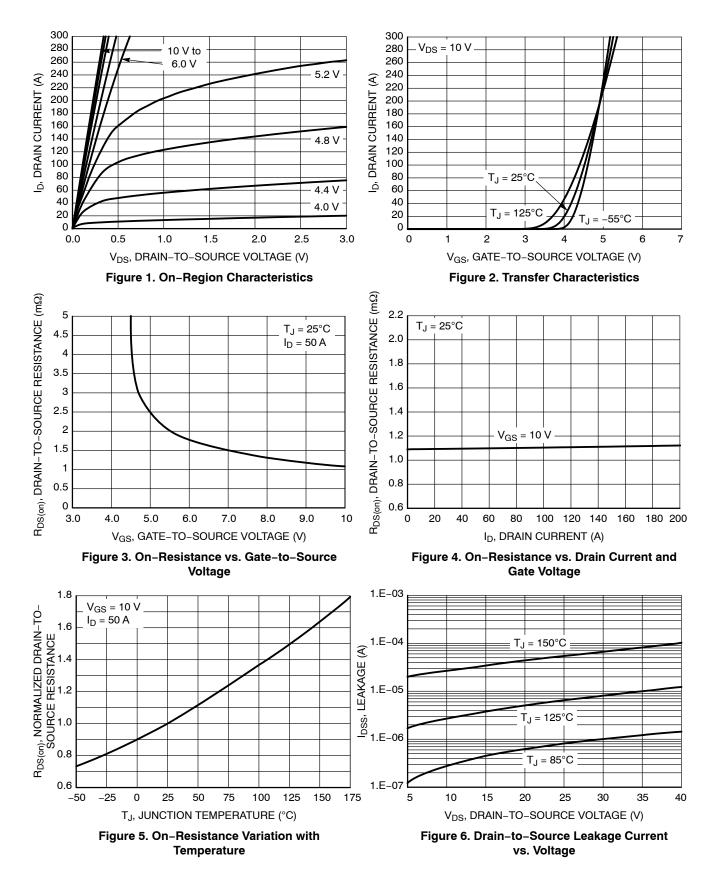
#### **DRAIN-SOURCE DIODE CHARACTERISTICS**

V <sub>SD</sub>	Forward Diode Voltage	V <sub>GS</sub> = 0 V, I <sub>S</sub> = 50 A	$T_J = 25^{\circ}C$	0.82	1.2	V
		I <sub>S</sub> = 50 A	T <sub>J</sub> = 125°C	0.68		v
t <sub>RR</sub>	Reverse Recovery Time			63		
t <sub>a</sub>	Charge Time	V <sub>GS</sub> = 0 V, dIS/dt = 100 A/μs, I <sub>S</sub> = 50 A		34		ns
t <sub>b</sub>	Discharge Time			29		
Q <sub>RR</sub>	Reverse Recovery Charge			92		nC

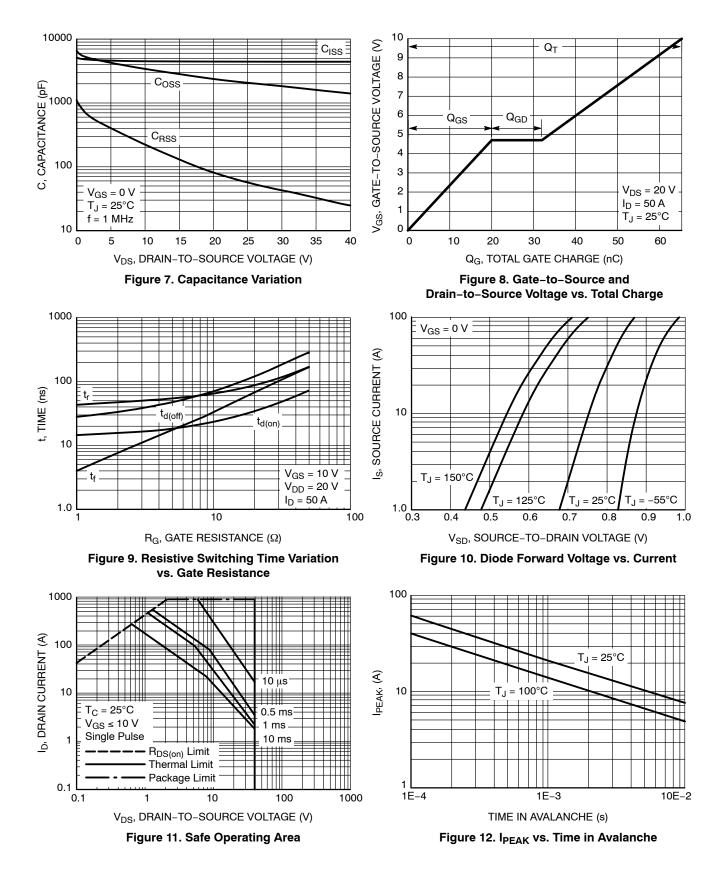
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Pulse Test: pulse width  $\leq$  300 µs, duty cycle  $\leq$  2%.

5. Switching characteristics are independent of operating junction temperatures.

# **TYPICAL CHARACTERISTICS**



### TYPICAL CHARACTERISTICS (continued)



## TYPICAL CHARACTERISTICS (continued)

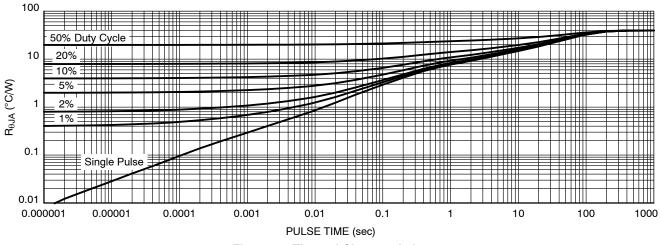


Figure 13. Thermal Characteristics

Device	Marking	Package	Shipping <sup>†</sup>
NVMFS5C426NT1G	5C426N	DFN5 (Pb-Free)	1500 / Tape & Reel
NVMFS5C426NET1G	5C426N	DFN5 (Pb-Free)	1500 / Tape & Reel
NVMFS5C426NET1G-YE	5C426N	DFN5 (Pb-Free)	1500 / Tape & Reel
NVMFS5C426NAFT1G	5C426N	DFN5 (Pb–Free)	1500 / Tape & Reel
NVMFS5C426NAFT1G-YE	5C426N	DFN5 (Pb-Free)	1500 / Tape & Reel
NVMFS5C426NWFAFT1G	426NWF	DFNW5 (Pb-Free, Wettable Flanks)	1500 / Tape & Reel
NVMFS5C426NWFET1G	426NWF	DFNW5 (Pb-Free, Wettable Flanks)	1500 / Tape & Reel

#### **DEVICE ORDERING INFORMATION**

#### **DISCONTINUED** (Note 6)

NVMFS5C426NWFT1G	426NWF	DFNW5 (Pb-Free, Wettable Flanks)	1500 / Tape & Reel
NVMFS5C426NT3G	5C426N	DFN5 (Pb–Free)	5000 / Tape & Reel
NVMFS5C426NWFT3G	426NWF	DFNW5 (Pb-Free, Wettable Flanks)	5000 / Tape & Reel

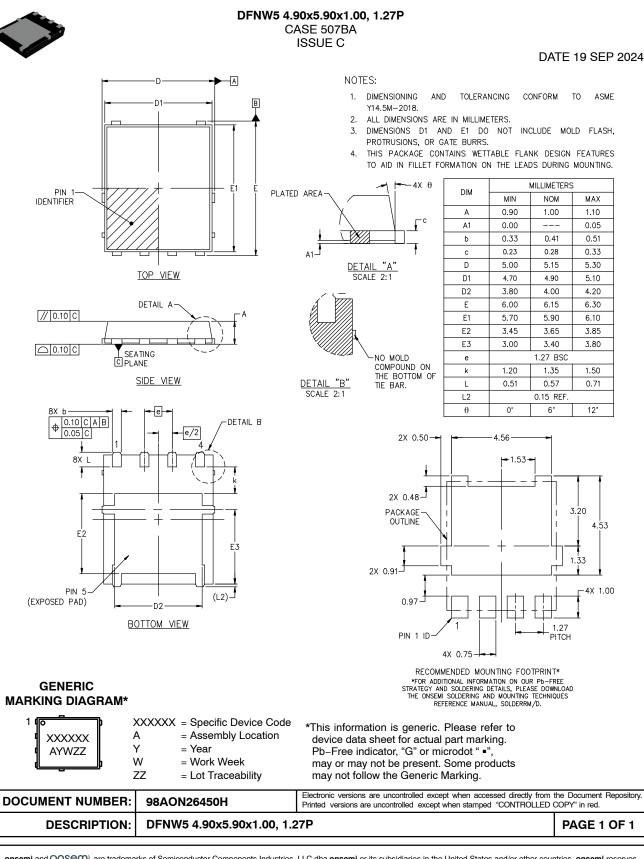
+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, <u>BRD8011/D</u>.

6. **DISCONTINUED:** These devices are not recommended for new design. Please contact your **onsemi** representative for information. The most current information on these devices may be available on <u>www.onsemi.com</u>.

# onsemi







onsemi and ONSEMi are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries. onsemi reserves the right to make changes without further notice to any products herein. onsemi makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.

onsemi, ONSEMI, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent\_Marking.pdf</u>. onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or indental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification. Buyer shall indemnify and hold onsemi and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs,

#### ADDITIONAL INFORMATION

TECHNICAL PUBLICATIONS:

Technical Library: www.onsemi.com/design/resources/technical-documentation onsemi Website: www.onsemi.com

ONLINE SUPPORT: <u>www.onsemi.com/support</u> For additional information, please contact your local Sales Representative at <u>www.onsemi.com/support/sales</u>